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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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In re application of: Mostafazadeh et al.

Atty Docket No. NSC1P217D1/NS-3877-1

Application No.: 09/399,585

Examiner: BEREZNY, N.

Filed: September 20, 1999

Group: 2813

Title: LEAD FRAME CHIP SCALE PACKAGE

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DECLARATION OF INVENTORS  
SHAHRAM MOSTAFAZADEH AND JOSEPH O. SMITH

As named inventors in U.S. Patent Application Nos. 09/399,585, we declare that:

1. WE are the inventors of the invention set forth in the above referenced application.
2. Figure 1A of the drawing illustrates a lead frame panel that we believe is part of our invention. Figure 1B illustrates the lead frame panel of Figure 1A populated with IC chips. Figure 1C illustrates a finished package in accordance with one embodiment of our invention.
3. We understand that Figures 1A – 1C were originally in the background section of the application. Accordingly, we understand that the Examiner has construed these drawings to be prior art to present invention.
4. We believe ourselves to be the inventors of the lead frame illustrated in Figure 1A and Figure 1B, and the inventors of the package illustrated in Figure 1C. We are unaware of any disclosures of these inventions by either ourselves or others that would cause them to be treated as prior art to the present application.
5. We understand that our prior counsel entered some proposed Amendments to the drawings which labeled these figures as prior art. We believe that that characterization is improper and that Figures 1A, 1B, and 1C are all part of our invention.

We hereby declare that all statements made herein of our own knowledge are true and that all statements made on information and belief are believed to be true. We further declare that these statements are made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both (under Section 1001 of Title 18 of

the United States Code), and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Date: 10/28/02

Shahram Mostafazadeh  
Shahram MOSTAFAZADEH

Date: 10/28/02

Joseph O. Smith  
Joseph O. SMITH